

## Powering innovative solutions

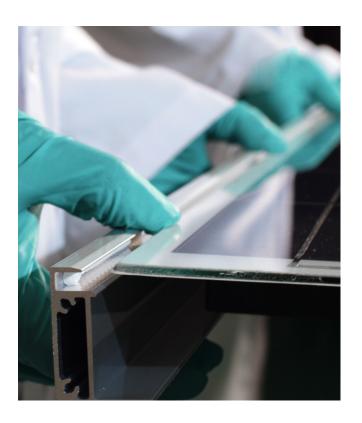
## Materials for PV assembly and repair

As the global photovoltaic (PV) market continues to grow, the demand for durable, reliable and better performing solar modules is critical. Dow delivers a wide base of chemistries and technologies in high-performance materials – tested to meet the specific requirements of the solar industry – that help to create more reliable solar modules.

Built on more than 50 years of expertise, we are collaborating with leading solar companies to improve durability, longevity, and performance of photovoltaic systems. We understand that materials drive innovation and are helping to solve the challenges in module manufacturing by leveraging our silicone, polyolefin, and polyurethane chemistries. Our successful material technologies are enabling PV module manufacturers to explore novel and more efficient designs. The designs for tomorrow's renewable energy needs.

Offering encapsulants and potting for your electronic components, rail bonding, frame sealing and junction box adhesives, repair and protective coatings, and materials for optics, we can help to make your applications more efficient, and more reliable.

Let us help you create modules with longer service life and better reliability. Contact one of our solar materials experts, and let's work together to make the global expansion of solar needed for the world's energy transition a reality.



F	Product	Consistency as supplied					
S	olar cell encapsulant						
	DOWSIL™ PV-6326 Solar Cell Encapsulation Silicone	Liquid					
	ENGAGE™ PV 8660 Polyolefin Elastomer	Solid pellet					
	ENGAGE™ PV 8669 Polyolefin Elastomer	Solid pellet					
	ENGAGE™ PV 8680 Polyolefin Elastomer	Solid pellet					
	ENGAGE™ PV 8688 Polyolefin Elastomer	Solid pellet					
J	unction box potting agent						
	DOWSIL™ PV-7326 Potting Agent	Liquid					
J	unction box adhesives, frame sealing						
	DOWSIL™ PV-8404 Fast Cure Bonding Adhesive	Paste - no slump					
	DOWSIL™ PV-804 Neutral Sealant	Paste - no slump					
F	Rail bonding, junction box bonding, frame sealing						
	DOWSIL™ PV-8301 Fast Cure Sealant	Paste - no slump					
	DOWSIL™ PV-8303 Ultra Fast Cure Sealant	Paste - no slump					
E	BIPV Structural glazing						
	DOWSIL™ 993N Structural Glazing Sealant	Paste - no slump					
	DOWSIL™ 993 Structural Glazing Sealant	Paste - no slump					
	DOWSIL™ 994 Ultra Fast Bonding Sealant	Paste - no slump					
	DOWSIL™ 983 Structural Glazing Sealant	Paste - no slump					
E	Backsheet repair coating						
	DOWSIL™ PV-9001 Backsheet Coating	Viscous liquid					
F	Product	Solvent					
E	Backsheet lamination adhesives						
	ADCOTE™ A 3302-E Solvent-Borne Adhesive	MEK					
	ADCOTE™ A 3302E EA Solvent-Borne Adhesive	Ethyl acetate					
	ADCOTE™ 503R Solvent-Borne Adhesive	MEK					
	Silicone Polyolefin Polyurethane	Curing Agent					

These are typical properties, not to be construed as specifications.

Viscosity or melt index	1- or 2-part	Cure system	Relative density (mixed)	Cure time/temperature	Color or transparent	Hardness Shore A	UL ratings
2800 mPa·s	2	Condensation	0.97	Gel time 9 hours at 23°C	Transparent	10	UL 94: HB UL 746B: RTI 105 UL 746C: Outdoor UV/H20 f2
5 dg/min	N/A	Peroxide	0.872		Transparent	66	
14 dg/min	N/A	Peroxide	0.873		Transparent	68	
5 dg/min	N/A	Peroxide	0.872		Transparent	66	
14 dg/min	N/A	Peroxide	0.873		Transparent	68	
3300 mPa⋅s	2	Condensation	1.42	Working time 7.6 min at 25°C Full cure time 75 hours at 25°C	White	37	UL 94: V0 UL 746A: HWI PLC2, HAI PLC0, CTI PLC0, UL746B: RTI 105
	2	Condensation	1.34	Snap time 5 min at 25°C Tack-free time 16 min at 25°C	Black	40	UL94: HB (1mm), V-1 (5mm) UL746A: CTI PLC0 UL746B: RTI 105
	1	Condensation	1.4	Tack-free time 30 min at 23°C 24 hours for each 2mm at 23°C	Black or White	39	UL 94: HB UL746A: HWI (5mm) PLC2, HAI (5mm) PLC0, CTI PLC1 UL 746B: RTI Elec 140, RTI Imp 105, RTI Str 115; UL 746C Outdoor UV/H20 f2
76000 mPa⋅s	2	Addition	1.31	Snap time 20-25 min at 25°C Full cure 8 hours at 25°C	Black	38-44	UL 94: HB UL 746A: HWI PLC3, HAI PLC0, CTI PLC0; UL 746B: RTI 105 UL 746C: Outdoor UV/H20 f2
350000 mPa·s	2	Addition	1.31	Snap time 8-10 min at 25°C Full cure 2.5 hours at 25°C	Black	38-44	
40000 mPa·s	2	Condensation	1.34	Snap time 20-60 min at 25°C	Black	39	
40000 mPa⋅s	2	Condensation	1.30	Working time 10-30 min Tack-free time 80-100 min at 25°C	Black	40	UL94: HB UL746A: HWI PLC2, HAI PLC0, CTI PLC0 UL746B: RTI 105
	2	Condensation	1.30	Tack-free time 5-18 min	Black	45	
40000 mPa⋅s	2	Condensation	1.30	Working time 10-25 min	Black	35-45	
28000 mPa⋅s	1	Condensation	1.30	Tack-free time 50 min at 23	White	19	UL94: HB UL746B: RTI 105
Viscos- ity at 25°C (mPa⋅s)	Solid Content (%)	Curing Agent Name	Solvent	Viscosity at 25°C (mPa⋅s)	Solid Content (%)	Mix Ratio <sup>3</sup>	Suggested Curing Conditions
500 900	45	DOW™ CR 865¹	Ethyl	400	75	100:10	6 days at 35°C¹
2400	51	DOW™ CR 865B²	acetate	400	75	100:20	3 days at 35°C²

When DOW™ CR 865 is used as a curing agent, the suggested curing condition is 6 days at 35°C
 When DOW™ CR 865B is used as a curing agent, the suggested curing condition is 3 days at 35°C
 Mixing ratios of 100:10 apply only to ADCOTE™ A 3302-E and ADCOTE™ A 3302E EA. Mixing ratio of 100:20 only applies to ADCOTE™ 503R.

## **Maximize reliable power** conversion

From the solar panel's DC output a solar energy system requires high-performance, dependable components to reliably optimize and convert the energy to be used or stored. Advanced silicone materials alllow enhanced warranties for the industry, based on their excellent aging resistance, under a wide range of harsh environments that outdoor devices can be exposed to during their lifetime. Our advanced adhesive, protective encapsulant and thermal management options protect outdoor electronics from environmental impacts, remove heat to raise performance efficiency, and offer long lifetime for solar power systems.

Solar power inverters used on strings of PV modules allow the energy harnessed to be converted into a useful form in order to return to the grid, be stored in a battery, or be used by the consumer.

Power optimizers and microinverters increase efficiency by mitigating power loss as a result of modules mismatch and allow more flexibility in solar installations.

Dow has multiple approved and demonstrated technologies to protect these important conversion devices, including thermal and gasketing options.



Thermal management  DOWSIL™ TC-8225 Thermally Conductive Gap Filler  DOWSIL™ TC-4551 CV Thermally Paste - no slump  DOWSIL™ TC-8335 Thermal Gel Paste - no slump  DOWSIL™ TC-8335 Thermally Conductive Gap Filler  DOWSIL™ TC-8335 Thermally Conductive Gap Filler  Paste - no slump  PCB protection coatings  DOWSIL™ EA-9187 LH Conformal Coating Liquid 440  DOWSIL™ EA-9187 LUV Conformal Coating Liquid 900  Electronics encapsulants  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant  DOWSIL™ EN-8760 Thermally Conductive Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  DOWSIL™ CN-8760 Thermally Liquid 4000  Power conversion assembly adhesives and sealants  DOWSIL™ EA-3838 Fast Adhesive Paste - no slump 150000  DOWSIL™ EA-3838 Fast Adhesive Paste - no slump 150000		Product	Consistency as supplied	Viscosity (mPa.s)					
DOWSIL™ TC-8225 Thermally Conductive Gap Filler  DOWSIL™ TC-4551 CV Thermally Conductive Gap Filler  DOWSIL™ TC-4551 CV Thermally Conductive Gap Filler  DOWSIL™ TC-8335 Thermal Gel  DOWSIL™ TC-5150 Thermally Conductive Gap Filler  Paste - no slump  Paste - no slump  260000  DOWSIL™ TC-5150 Thermally Conductive Gap Filler  Paste - no slump  Poste - no slump  2360000  PCB protection coatings  DOWSIL™ EA-9187 L H Conformal Coating  Liquid  DOWSIL™ EA-9187 L UV Conformal Coating  Liquid  DOWSIL™ EA-9187 L UV Conformal Coating  Liquid  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Liquid  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Liquid  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  Paste - no slump  150000	<b>-</b>	hermal management	as supplied	(iiii a.s)					
Conductive Gap Filler       no slump       200000         DOWSIL™ TC-4551 CV Thermally Conductive Gap Filler       250000       250000         DOWSIL™ TC-8335 Thermal Gel       Paste - no slump       260000         DOWSIL™ TC-5150 Thermally Conductive Gap Filler       Paste - no slump       2360000         PCB protection coatings         DOWSIL™ EA-9187 L H Conformal Coating       Liquid       440         DOWSIL™ EA-9187 L UV Conformal Coating       Liquid       900         Electronics encapsulants       Liquid       950         Electronics encapsulants       Liquid       1700         DOWSIL™ EE-3200 Low Stress Silicone Encapsulant       Liquid       2700         DOWSIL™ CN-8760 Thermally Conductive Encapsulant       Liquid       4000         Power conversion assembly adhesives and sealants         DOWSIL™ EA-3838 Fast Adhesive       Paste - no slump       150000         POWSIL™ EA-3838 Fast Adhesive       Paste - no slump       150000	i								
Conductive Gap Filler       no slump       250000         DOWSIL™ TC-8335 Thermal Gel       Paste - no slump       260000         DOWSIL™ TC-5150 Thermally Conductive Gap Filler       Paste - no slump       2360000         PCB protection coatings         DOWSIL™ EA-9187 LH Conformal Coating       Liquid       440         DOWSIL™ EA-9187L UV Conformal Coating       Liquid       900         Electronics encapsulants         DOWSIL™ EF-3200 Low Stress Silicone Encapsulant       Liquid       1700         DOWSIL™ CN-8760 Thermally Conductive Encapsulant       Liquid       2700         POWSIL™ TC-6015 Thermally Conductive Encapsulant       Liquid       4000         Power conversion assembly adhesives and sealants         DOWSIL™ EA-3838 Fast Adhesive       Paste - no slump       150000         POWSIL™ PV-804 Neutral Sealant				200000					
DOWSIL™ TC-8335 Thermal Gel  DOWSIL™ TC-5150 Thermally Conductive Gap Filler  Paste - no slump  PCB protection coatings  DOWSIL™ EA-9187 LH Conformal Coating  Liquid  DOWSIL™ EA-9187L UV Conformal Coating  Liquid  DOWSIL™ 1-2577 Conformal Coating  Liquid  DOWSIL™ 1-2577 Conformal Coating  Electronics encapsulants  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Paste - no slump  150000				250000					
PCB protection coatings  DOWSIL™ FA-9187 LH Conformal Coating Liquid 440  DOWSIL™ EA-9187L UV Conformal Coating Liquid 900  DOWSIL™ EA-9187L UV Conformal Coating Liquid 950  Electronics encapsulants  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant Liquid 1700  DOWSIL™ CN-8760 Thermally Conductive Encapsulant Liquid 2700  DOWSIL™ CN-8760 Thermally Conductive Encapsulant Liquid 4000  Power conversion assembly adhesives and sealants  DOWSIL™ EA-3838 Fast Adhesive Paste - no slump 150000		DOWSIL™ TC-8335 Thermal Gel		260000					
DOWSIL™ EA-9187 LH Conformal Coating       Liquid       440         DOWSIL™ EA-9187L UV Conformal Coating       Liquid       900         DOWSIL™ 1-2577 Conformal Coating       Liquid       950         Electronics encapsulants         DOWSIL™ EE-3200 Low Stress Silicone Encapsulant       Liquid       1700         DOWSIL™ CN-8760 Thermally Conductive Encapsulant       Liquid       2700         DOWSIL™ TC-6015 Thermally Conductive Encapsulant       Liquid       4000         Power conversion assembly adhesives and sealants       Paste - no slump       150000         DOWSIL™ EA-3838 Fast Adhesive       Paste - no slump       150000		DOWSIL™ TC-5150 Thermally Conductive Gap Filler		2360000					
DOWSIL™ EA-9187L UV Conformal Coating  Liquid 900  DOWSIL™ 1-2577 Conformal Coating  Liquid 950  Electronics encapsulants  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant  Liquid 1700  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Liquid 2700  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  Liquid 4000  Power conversion assembly adhesives and sealants  DOWSIL™ EA-3838 Fast Adhesive  Paste - no slump 150000	F	PCB protection coatings							
DOWSIL™ 1-2577 Conformal Coating  Electronics encapsulants  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant  Liquid 1700  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Liquid 2700  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  Liquid 4000  Power conversion assembly adhesives and sealants  DOWSIL™ EA-3838 Fast Adhesive  Paste - no slump 150000		DOWSIL™ EA-9187 LH Conformal Coating	Liquid	440					
Electronics encapsulants  DOWSIL™ EE-3200 Low Stress Silicone Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Liquid 2700  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  Liquid 4000  Power conversion assembly adhesives and sealants  DOWSIL™ EA-3838 Fast Adhesive  Paste - no slump 150000		DOWSIL™ EA-9187L UV Conformal Coating	Liquid	900					
DOWSIL™ EE-3200 Low Stress Silicone Encapsulant       Liquid       1700         DOWSIL™ CN-8760 Thermally Conductive Encapsulant       Liquid       2700         DOWSIL™ TC-6015 Thermally Conductive Encapsulant       Liquid       4000         Power conversion assembly adhesives and sealants         DOWSIL™ EA-3838 Fast Adhesive       Paste - no slump       150000         DOWSIL™ EA-3804 Neutral Sealant       Paste - no slump       150000		DOWSIL™ 1-2577 Conformal Coating	Liquid	950					
Silicone Encapsulant  DOWSIL™ CN-8760 Thermally Conductive Encapsulant  Liquid  2700  DOWSIL™ TC-6015 Thermally Conductive Encapsulant  Liquid  4000  Power conversion assembly adhesives and sealants  DOWSIL™ EA-3838 Fast Adhesive  Paste - no slump  150000  Paste -	E	lectronics encapsulants							
Conductive Encapsulant       Liquid       2700         DOWSIL™ TC-6015 Thermally Conductive Encapsulant       Liquid       4000         Power conversion assembly adhesives and sealants         DOWSIL™ EA-3838 Fast Adhesive       Paste - no slump       150000         DOWSIL™ PV-804 Neutral Sealant       Paste -			Liquid	1700					
Power conversion assembly adhesives and sealants  DOWSILTM FA-3838 Fast Adhesive  Paste - no slump  Power LTM PV-804 Neutral Sealant  Paste -			Liquid	2700					
DOWSIL™ FA-3838 Fast Adhesive  Paste - no slump  150000  Paste - Paste -			Liquid	4000					
DOWSIL TM PV-804 Neutral Sealant  Paste -	F	Power conversion assembly adhesives and sealants							
DOWSIL M PV-804 Neutral Sealant		DOWSIL™ EA-3838 Fast Adhesive		150000					
		DOWSIL™ PV-804 Neutral Sealant							
Electrically conductive adhesive	E	lectrically conductive adhesive							
DOWSIL™ EC-8425 Electrically Conductive Adhesive  Paste - no slump  400000				400000					



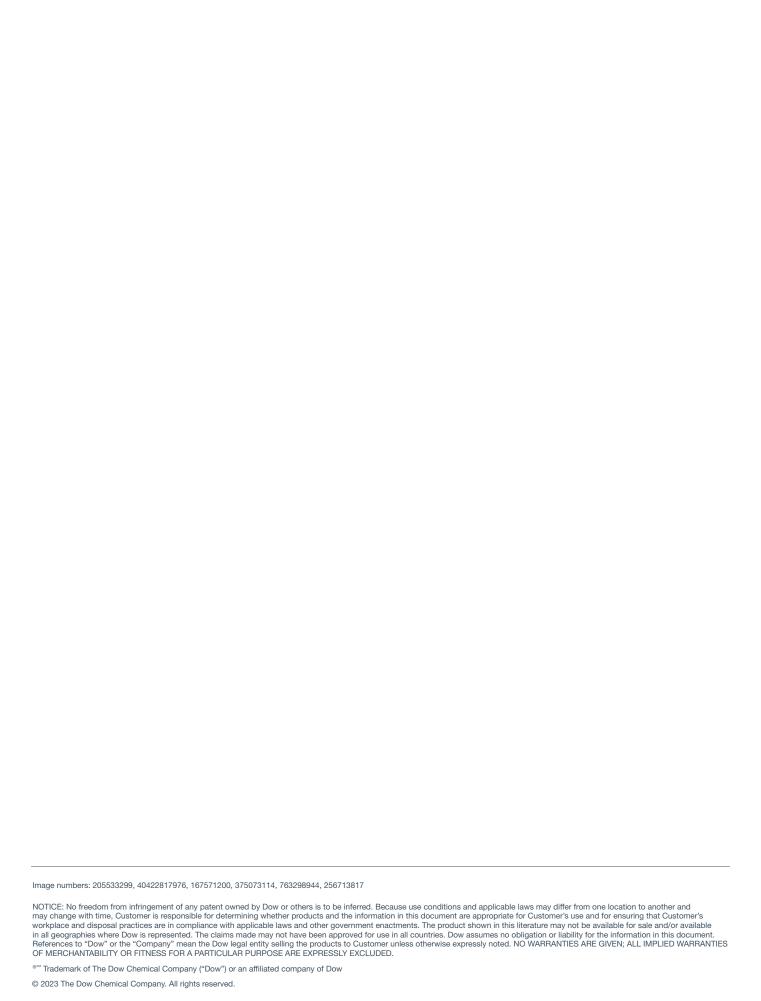
1- or 2-part	Cure system	Relative density (mixed)	Cure time/ temperature	Color or transparent	Hardness Shore A	Thermal conductivity (W/mK)	UL ratings
2	Addition	2.9	2 hours at 25°C 10 min at 80°C	Blue	55 (shore 00)	2.7	UL 94: V0 UL746A: HWI PLC1, HAI PLC1, CTI PLC0 UL746B: RTI 150
2	Addition	3.3	2 hours at 25°C 15 min at 80°C	Blue	54 (shore 00)	5.2	UL 94: V0 UL746B: RTI 150
1	Addition	3.2	60 min at 60°C 10 min at 120°C	Pink	75 (shore 00)	4	
1	Non curing	3.47	NA	Blue	NA	5	
1	Condensation	0.98	Skin over time 7 min at 25°C	Clear	21		UL94: V0 (1.5mm laminate) UL746E indoor certified, RTI 130
1	Condensation	0.98	Skin over time 9 min at 25°C	Transluscent	17		UL94: V0 (1.5mm laminate) UL746E indoor & outdoor certified, RTI 105
1	Condensation	1.11	Tack-free time 7 min at 25°C	Transluscent	80		UL94: V0, 5VA UL746B: RTI 105 UL746E indoor & outdoor certified, RTI 130
2	Addition	1.47	3 hours at 25°C 20 min at 50°C	Dark Grey	43 (shore 00)		UL94: V-0 UL746A: HWI PLC4, HAI PLC1, CTI PLC0 UL746B: RTI 150
2	Addition	1.6	40 min at 50°C	Dark Grey	55		UL94: V-0 UL746A: HWI PLC0, HAI PLC0, CTI PLC0 UL746B: RTI 150
2	Addition	2.25	3 hours at 25°C 30 min at 70°C	Grey	40		UL94: V-0 UL746A: HWI (1.5mm) PLC2, (3mm) PLC0, HAI PLC0, CTI PLC0 UL746B: RTI 150
2	Condensation	1.4	Tack-free time 5-8 min at 25°C (2:1 ratio) >0.5Mpa in 15 min	Black	40		UL94: V-1 (5mm) UL746A: CTI PLC0 UL746B: RTI 105
1	Condensation	1.4	Tack-free time 30 min at 23°C 24 hours for each 2mm at 23°C	Black or White	39		UL 94: HB UL746A: HWI (5mm) PLC2, HAI (5mm) PLC0, CTI PLC1 UL 746B: RTI Elec 140, RTI Imp 105, RTI Str 115 UL 746C: Outdoor UV/H20 f2
1	Addition	2.2	90 min at 90°C 10 min at 150°C	Tan	40 (shore D)		





## Learn more

We bring more than just an industry-leading portfolio of advanced organic and silicone-based materials. As your dedicated innovation leader, we bring proven process and application expertise, a network of technical experts, a reliable global supply base and world-class customer service. To find out how we can help to support your applications, visit **dow.com/solar** or contact your Dow representative.



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